

Degradation and Effective Encapsulation of Few-Layer 1T'-MoTe₂ thin Film

Zijian Xie^{1,2}, Li Yang^{1,2}, Hao Wu^{1,2}, Jie Li^{1,2}, Xun Lou^{1,2}, Rui Zhu^{1,2}, Xu Yu^{1,2}, Haixin Chang^{1,2} and Wenfeng Zhang^{1,2*}

¹Center for Joining and Electronic Packaging, State Key Laboratory of Material Processing and Die & Mould Technology, School of Materials Science and Engineering, Huazhong University of Science and Technology, 1037#, Luoyu Road, Wuhan, 430074, P.R. China

²Shenzhen R&D Center of Huazhong University of Science and Technology, Shenzhen 518000, PRC.
Phone: +86-18694071968 E-mail: wfzhang@hust.edu.cn

Abstract

We have investigated the degradation of CVD-grown few-layer 1T'-MoTe₂ thin film. Surface oxidation of both Mo and Te atoms easily occurs even at room temperature, while Mo atoms show preferential oxidation in comparison with Te. Notably, Raman-active Te metalloid is identified as the byproduct of MoTe₂ oxidation. We further demonstrate that encapsulation by a thin PMMA coating can effectively prevent the degradation of few-layer MoTe₂ film at the ambient conditions.

1. Introduction

Molybdenum- and tungsten-based transition-metal dichalcogenides (TMDCs) such as MoTe₂ and WTe₂ attract intense research interests owing to their fascinating properties [1-2]. Notably, recent investigations predicts distorted octahedral (1T') TMDCs to be semimetallic topological insulators, implying their crucial application for developing topological quantum computing devices[3]. Unfortunately, 1T' TMDCs generally exhibit severe surface chemical instability, which hampers their application possibilities. In this regard, a thorough understanding of their degradation behavior is obviously desirable while are much less investigated experimentally.

In this study, we present an oxygen-induced degradation of few-layer 1T'-MoTe₂ thin film grown by CVD method. We demonstrate that Surface oxidation of both Mo and Te atoms occurs at the ambient condition, and Raman-active Te metalloids would emerge and vanish relying on the oxidation temperature. By spin-coating a dense PMMA film, MoTe₂ thin film can be effective encapsulated. The results provide a solid understanding of MoTe₂ ambient instability and offer a feasible protective method, which might accelerate its future topological quantum computing related-applications.

2. Experimental

Few-layer 1T'-MoTe₂ film was grown by chemical vapor deposition (CVD) onto 300 nm SiO₂/Si substrate using high tellurization velocity [4]. Its structural characteristics and polymorphism were identified by Raman Spectroscopy and X-ray Photoelectron Spectroscopy (XPS). To evaluate the degradation behavior, as-synthesized 1T'-MoTe₂ film was kept at ambient condition for several hours, and then further annealed under the pure oxygen atmosphere for 30 min at different temperature ranging from 100°C to 400°C, respectively. Structural deterioration was evaluated by Raman Spectroscopy and XPS. To protect MoTe₂ thin film,

a dense layer of PMMA film was spin coated onto the surface of MoTe₂ under the optimized condition immediately after the CVD growth. Encapsulation effect was evaluated after 1 week by removing PMMA coating using the argon ion etching in XPS.

3. Results and Discussion

The optical images of as-synthesized MoTe₂ thin film is shown in **Figure 1 (a)**, indicating the film is uniform and continuous across the entire area. Raman spectrum (**Figure 1 (b)**) exhibits five prominent Raman modes at 108(A_u), 127(A_g), 161(B_g), 189(B_g) and 257(A_g) cm⁻¹, respectively, verifies the film as 1T'-MoTe₂ film. The film is about five layers with a thickness ~4.33 nm characterized by atomic force spectroscopy (AFM), as shown in **Figure 1(c)**. **Figure 1(d)** shows the chemical states by XPS, which the prominent Mo 3d and Te 3d peaks can be assigned to Mo-Te bonds. The Mo/Te atomic ratio was determined to be around 1:2 by XPS, indicating the as-grown MoTe₂ film possesses a good stoichiometry.

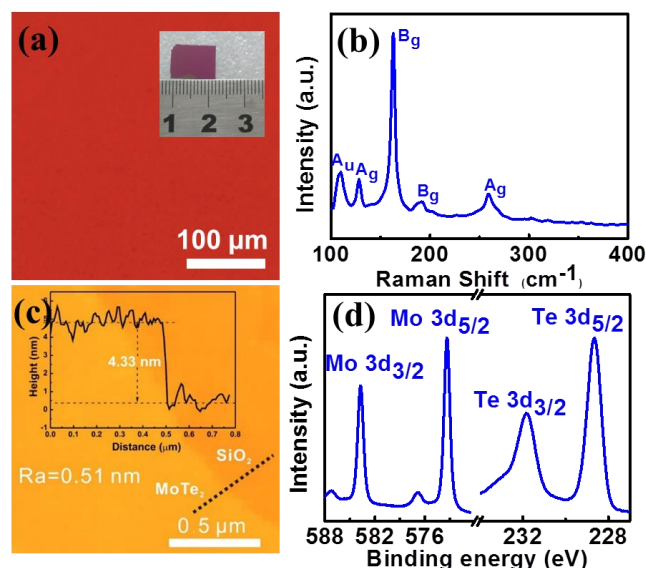


Figure 1. Characterization of CVD-grown 1T'-MoTe₂ thin film. (a) Optical images of 1T'-MoTe₂ film on ~1.0 × 1.0 cm SiO₂/Si substrates; (b) Representative Raman spectrum taken at several different locations; (c) Atomic force microscopy (AFM) image to reveal the thickness and roughness; (d) Mo 3d and Te 3d XPS analysis.

To reveal the oxygen-induced degradation, XPS analysis of 1T'-MoTe₂ film before and after O₂ annealing at different temperature for 30 min was performed, as shown in **Figure 2**. For pristine 1T'-MoTe₂, only Mo 3d_{5/2} (228.5 eV) together with Mo 3d_{3/2} (231.6 eV) and Te 3d_{5/2} (573.1

eV) together with Te 3d_{3/2} (583.5 eV) can be observed, which are assigned to the Mo-Te bonds. When the pristine 1T'-MoTe₂ film was exposed at the ambient condition, new Mo-O bonds (233.15 eV and 236.25 eV), and Te-O bonds (576.89 eV and 587.26 eV) obviously arise, suggesting MoTe₂ surface is easily oxidized to form MoO_x-TeO₂ layer. The intensity of both Mo-O bonds and Te-O bonds was found to increase with the increase of oxygen annealing temperature, confirming the enhanced oxidation behavior of MoTe₂ surface. Interestingly, another new doublet peaks of Te 3d (584.3 and 573.9 eV) appears at 350 °C, which can not be assigned as Mo-Te band or Te-O band, while is more close proximity to Te-Te bonds. Such observation implies that Te metalloids might be another byproduct of MoTe₂ oxidation relying on the degradation condition. We also noticed that only Mo-O bonds and Te-O bonds can be observed with further increase of annealing temperature to 400 °C, indicating the Te metalloids should be decomposed and the 1T'-MoTe₂ film has been fully oxidized into MoO_x-TeO₂ layer at 400 °C.

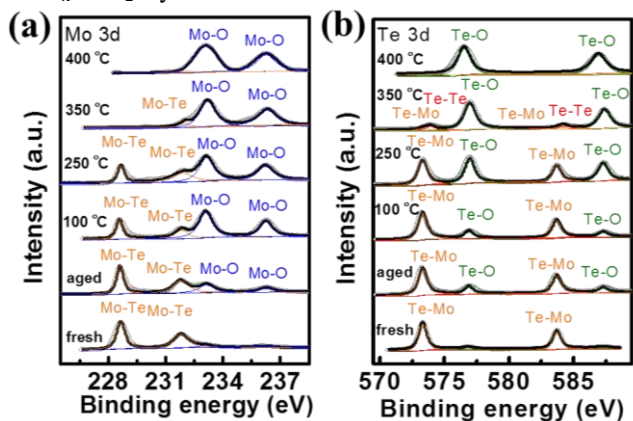


Figure 2. Mo 3d (a) and Te 3d (b) XPS analysis of few-layer 1T'-MoTe₂ film before and after O₂ annealing with a constant flow rate (50 sccm) at different temperature for 30 min.

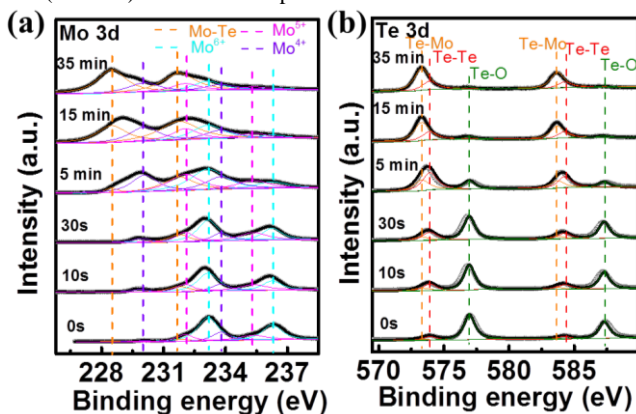


Figure 3. Mo 3d (a) and Te 3d (b) XPS spectra evolution as a function of argon ion etching time to remove the surface oxide layer for the oxidized 1T'-MoTe₂ film.

To clarify the oxidation behavior of 1T'-MoTe₂ film, XPS analysis of oxidized 1T'-MoTe₂ film as a function of argon ion etching time to remove the MoO_x-TeO₂ layer was further performed, as shown in **Figure 3**. Both the intensities of MoO_{3-x} ($x \leq 3$) and TeO₂ doublet peaks gradually decrease with the etching time increases, suggesting the oxide film is gradually thinned. Significantly,

the intensity of MoO_{3-x} ($x \leq 3$) is always higher than the TeO₂ after etching, and even small amount of MoO_{3-x} still remain on the MoTe₂ surface although TeO₂ has been completely removed after etching 35 min. Such observation implies a preferential oxidation of Mo in MoTe₂ film compared with Te atoms.

Furthermore, the emergence and decomposition of Te metalloids were identified by Raman analysis. As shown in **Figure 4 (a)**, no significant change of Raman-active modes is observed for pristine and degraded 1T'-MoTe₂ film exposed at ambient the condition and annealed at 100 °C, while two new peaks (A and B) at 123 cm⁻¹ and 143 cm⁻¹ similar with Raman features of Te particles show up when the annealing temperature is above 250 °C. Such observation further confirms the Te metalloids as oxidation byproduct, which is consistent with XPS analysis above. We also found the intensity of 1T'-MoTe₂ Raman peaks gradually decreases till to completely vanishes, and the intensity of peaks A and B obviously increases when the annealing temperature increases from 250 °C to 350 °C. Such results suggest Raman analysis is an feasible way to characterize the Te metalloids during the degradation of MoTe₂ film compared with XPS. Similar with XPS analysis, Raman peaks A and B cannot be observed at 400 °C, which confirms the decomposition of Te metalloids.

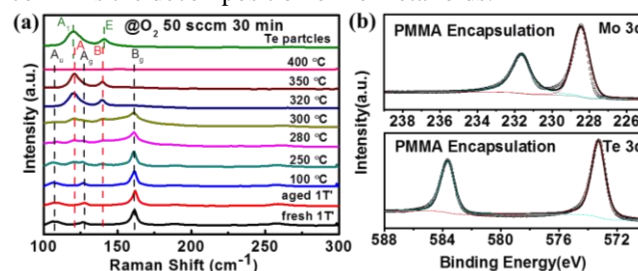


Figure 4. (a) Raman-active modes of 1T'-MoTe₂ film before and after O₂ annealing with a constant oxygen flow rate (50 sccm) at different temperature for 30 min. (b) Mo 3d and Te 3d XPS analysis to evaluate the effect of PMMA encapsulation.

To protect the MoTe₂ film, a dense layer of PMMA was spin coated onto the MoTe₂ surface immediately after the CVD growth. After exposure to ambient condition with PMMA protection for 1 week, PMMA layer was removed by argon ion etching for XPS characterization. As shown in **Figure 4(b)**, both Mo 3d and Te 3d spectrum show no Mo-O and Te-O bonds, suggesting an effective encapsulation of MoTe₂ with the coated PMMA film.

4. Conclusion

We have demonstrated a preferential oxidation of Mo in few-layer 1T'-MoTe₂ film at the ambient condition. Raman-active Te metalloid is identified as the byproduct of MoTe₂ oxidation. A thin PMMA coating was verified to be an effective way to prevent the degradation of MoTe₂ Film at ambient condition.

Acknowledgements

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